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SEMICONDUCTOR®

September 2010

FDMC7692 N-Channel Power Trench[®] MOSFET 30 V, 13.3 A, 8.5 m Ω

Features

- Max r_{DS(on)} = 8.5 mΩ at V_{GS} = 10 V, I_D = 13.3 A
- Max r_{DS(on)} = 11.5 mΩ at V_{GS} = 4.5 V, I_D = 10.6 A
- High performance technology for extremely low r_{DS(on)}
- Termination is Lead-free and RoHS Compliant

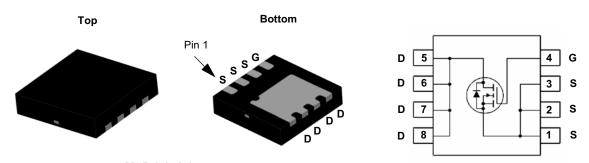


General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench[®] process that has been especially tailored to minimize the on-state resistance. This device is well suited for Power Management and load switching applications common in Notebook Computers and Portable Battery Packs.

Application

- DC DC Buck Converters
- Notebook battery power management
- Load switch in Notebook



MLP 3.3x3.3

MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			30	V	
V _{GS}	Gate to Source Voltage			±20	V	
I _D	Drain Current -Continuous (Package limited)	T _C = 25 °C		16		
	-Continuous	T _A = 25 °C	(Note 1a)	13.3	A	
	-Pulsed			40		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	58	mJ	
P _D	Power Dissipation	T _C = 25 °C		29		
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.3		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

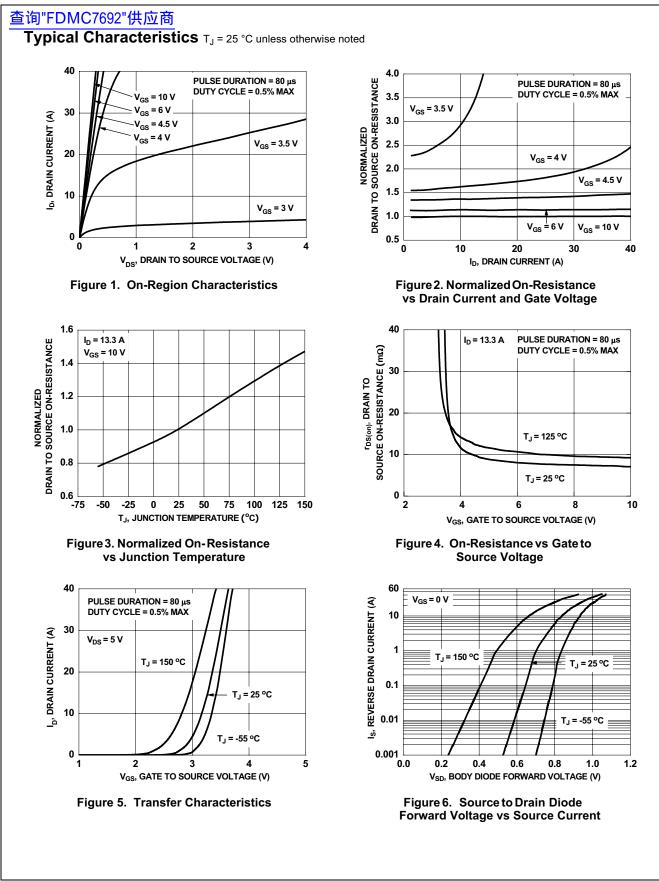
$R_{\theta JC}$	Thermal Resistance, Junction to Case	4.3	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a)	53	C/vv

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC7692	FDMC7692	MLP 3.3x3.3	13 "	12 mm 3000 u	

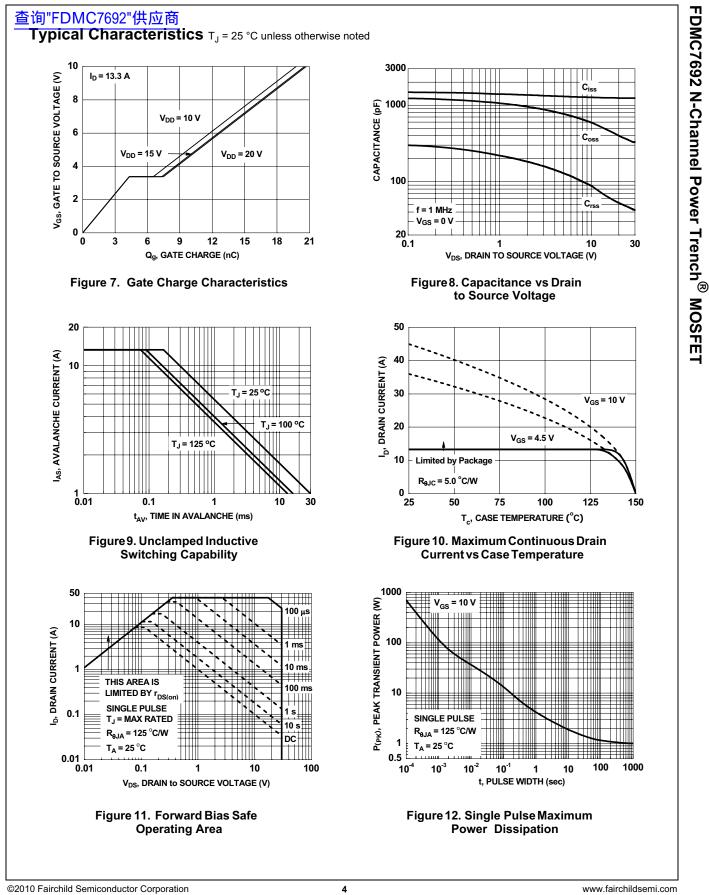
down Voltage mperature in Current ge Current old Voltage old Voltage tt	$V_{GS} = 20 \text{ V}, \text{ V}_{DS} = 0$ $V_{GS} = V_{DS}, \text{ I}_{D} = 250$ $I_{D} = 250 \mu\text{A}, \text{ reference}$ $V_{GS} = 10 \text{V}, \text{ I}_{D} = 13.$	xed to 25 °C V $T_J = 125 °C$ V μA xed to 25 °C	30	16 1.9 -6	1 250 100 3.0	V mV/°C μA nA V
in Current ge Current old Voltage old Voltage	$\begin{split} & V_{DS} = 250 \ \mu\text{A}, \ \text{reference} \\ & V_{DS} = 24 \ \text{V}, \ \text{V}_{GS} = 0 \\ & V_{GS} = 20 \ \text{V}, \ \text{V}_{DS} = 0 \\ & V_{GS} = 20 \ \text{V}, \ \text{V}_{DS} = 0 \\ & I_{D} = 250 \ \mu\text{A}, \ \text{reference} \\ & I_{D} = 250 \ \mu\text{A}, \ \text{reference} \\ & V_{GS} = 10 \ \text{V}, \ I_{D} = 13. \end{split}$	xed to 25 °C V $T_J = 125 °C$ V μA xed to 25 °C		1.9	250 100	mV/°C - μA nA V
in Current ge Current old Voltage old Voltage	$\begin{split} & V_{DS} = 250 \ \mu\text{A}, \ \text{reference} \\ & V_{DS} = 24 \ \text{V}, \ \text{V}_{GS} = 0 \\ & V_{GS} = 20 \ \text{V}, \ \text{V}_{DS} = 0 \\ & V_{GS} = 20 \ \text{V}, \ \text{V}_{DS} = 0 \\ & I_{D} = 250 \ \mu\text{A}, \ \text{reference} \\ & I_{D} = 250 \ \mu\text{A}, \ \text{reference} \\ & V_{GS} = 10 \ \text{V}, \ I_{D} = 13. \end{split}$	xed to 25 °C V $T_J = 125 °C$ V μA xed to 25 °C	1.2	1.9	250 100	- μA nA V
ge Current old Voltage old Voltage nt	$V_{GS} = 20 \text{ V}, \text{ V}_{DS} = 0$ $V_{GS} = V_{DS}, \text{ I}_{D} = 250$ $I_{D} = 250 \mu\text{A}, \text{ reference}$ $V_{GS} = 10 \text{V}, \text{ I}_{D} = 13.$	T _J = 125 °C V μA ced to 25 °C	1.2		250 100	nA V
old Voltage old Voltage nt	$V_{GS} = 20 \text{ V}, \text{ V}_{DS} = 0$ $V_{GS} = V_{DS}, \text{ I}_{D} = 250$ $I_{D} = 250 \mu\text{A}, \text{ reference}$ $V_{GS} = 10 \text{V}, \text{ I}_{D} = 13.$	μA ced to 25 °C	1.2		100	V
old Voltage old Voltage nt	$V_{GS} = V_{DS}, I_D = 250$ $I_D = 250 \ \mu\text{A}, \text{ reference}$ $V_{GS} = 10 \ \text{V}, I_D = 13.$	μA ced to 25 °C	1.2		3.0	
old Voltage ht	$I_D = 250 \ \mu\text{A}, \text{ reference}$ $V_{GS} = 10 \ \text{V}, \ I_D = 13.$	ced to 25 °C	1.2		3.0	
old Voltage ht	$I_D = 250 \ \mu\text{A}, \text{ reference}$ $V_{GS} = 10 \ \text{V}, \ I_D = 13.$	ced to 25 °C	1.2		0.0	
nt	V _{GS} = 10 V, I _D = 13.			-6		\//°C
On Resistance		3 A				IIIV/ C
On Resistance	$V_{GS} = 4.5 V_{.1D} = 10$			7.2	8.5	
	1 00 ···· · · · · · · · · · · · · · · ·	V _{GS} = 4.5 V, I _D = 10.6 A			11.5	mΩ
	V _{GS} = 10 V, I _D = 13.3	3 A, T _J = 125 °C		9.5	12.0	1
ance	V _{DD} = 5 V, I _D = 13.3	A		60		S
				1260	1680	pF
	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz			480	635	pF
citance						pF
						Ω
	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$			3	10	ns ns
		_		3	10	ns
				21	29	nC
				10	14	nC
		_D = 13.3 A		5		nC
Charge				3		nC
teristics						
Source to Drain Diode Forward Voltage		A (Note 2)		0.86	1.2	V
	V _{GS} = 0 V, I _S = 1.9 A	(Note 2)		0.75	1.2	
	I _⊏ = 13.3 A. di/dt = 10	00 A/us		24	38	ns
arge	$-1F = 13.3 \text{ A}, \text{ u/ut} = 100 \text{ A/}\mu\text{s}$			7	14	nC
	acitance	acitance f = 1 MHz acitance V _{DD} = 15 V, I _D = 13.3 V _{GS} = 10 V, R _{GEN} = V _{GS} = 0 V to 10 V V _{GS} = 0 V to 10 V V _{GS} = 0 V to 4.5 V Charge Forward Voltage V _{GS} = 0 V, I _S = 13.3 A I _E = 13.3 A, di/dt = 10	acitance V_{DD} = 15 V, I_D = 13.3 A, V_{GS} = 10 V, R_{GEN} = 6 \Omega V_{GS} = 0 V to 10 V V_{GS} = 0 V to 4.5 V V_{DD} = 13.3 A Charge V_{GS} = 0 V, I_S = 13.3 A Keristics Forward Voltage V_{GS} = 0 V, I_S = 1.9 A I_E = 13.3 A, di/dt = 100 A/us	acitance f = 1 MHz acitance V _{DD} = 15 V, I _D = 13.3 A, V _{GS} = 10 V, R _{GEN} = 6 Ω V _{GS} = 0 V to 10 V V _{GS} = 0 V to 10 V V _{GS} = 0 V to 4.5 V V _{DD} = 15 V, I _D = 13.3 A V _{GS} = 0 V to 4.5 V V _{DD} = 15 V I _D = 13.3 A Charge V _{GS} = 0 V, I _S = 13.3 A V _{GS} = 0 V, I _S = 1.9 A (Note 2) V _{GS} = 0 V, I _S = 1.9 A I _E = 13.3 A, di/dt = 100 A/us	VDS = 15 V, VGS = 0 V, 480 acitance 65 VDD = 15 V, ID = 13.3 A, 0.9 VGS = 10 V, RGEN = 6 Ω 21 VGS = 0 V to 10 V 21 VGS = 0 V to 4.5 V 21 VDD = 13.3 A 3 VGS = 0 V to 4.5 V 10 VGS = 0 V to 4.5 V 10 VGS = 0 V to 4.5 V 3 Charge 3 Charge 3 VGS = 0 V, IS = 13.3 A 5 Charge 0.86 VGS = 0 V, IS = 1.9 A 0.75 Ie Ic = 13.3 A, di/dt = 100 A/us 24	VDS = 15 V, VGS = 0 V, f = 1 MHz 480 635 acitance 65 100 0.9 2.4 VDD = 15 V, ID = 13.3 A, VGS = 10 V, RGEN = 6 Ω 9 18 VGS = 10 V, RGEN = 6 Ω 21 33 VGS = 0 V to 10 V VGS = 0 V to 4.5 V VDD = 15 V ID = 13.3 A 21 29 VGS = 0 V to 4.5 V VDD = 13.3 A 10 14 14 Charge VGS = 0 V, IS = 13.3 A 5 10 14 Charge VGS = 0 V, IS = 13.3 A 0.86 1.2 VGS = 0 V, IS = 1.3 A 0.75 1.2 Vee Ic = 13.3 A, di/dt = 100 A/us 24 38

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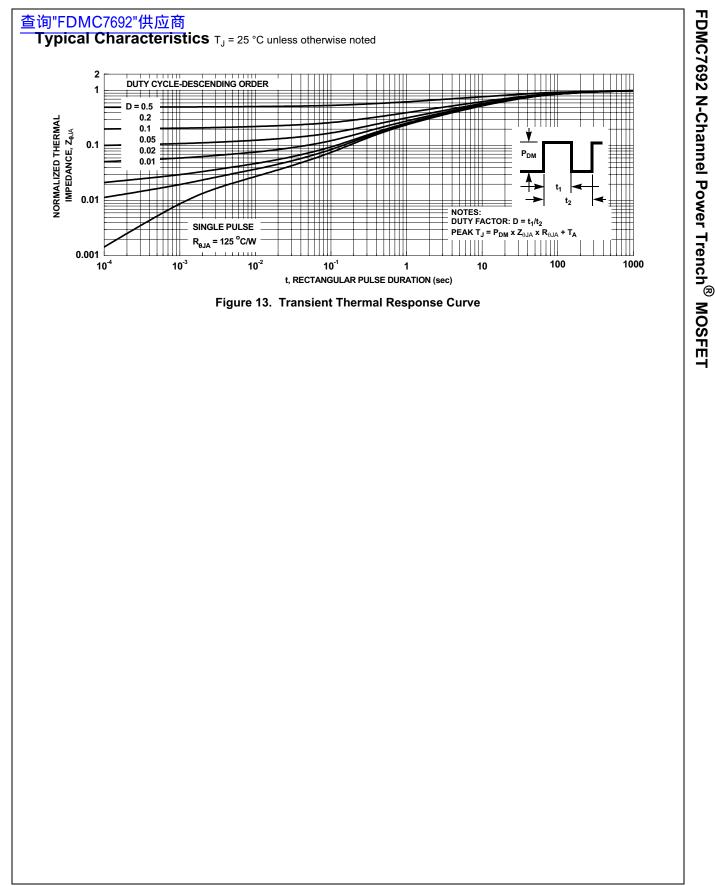


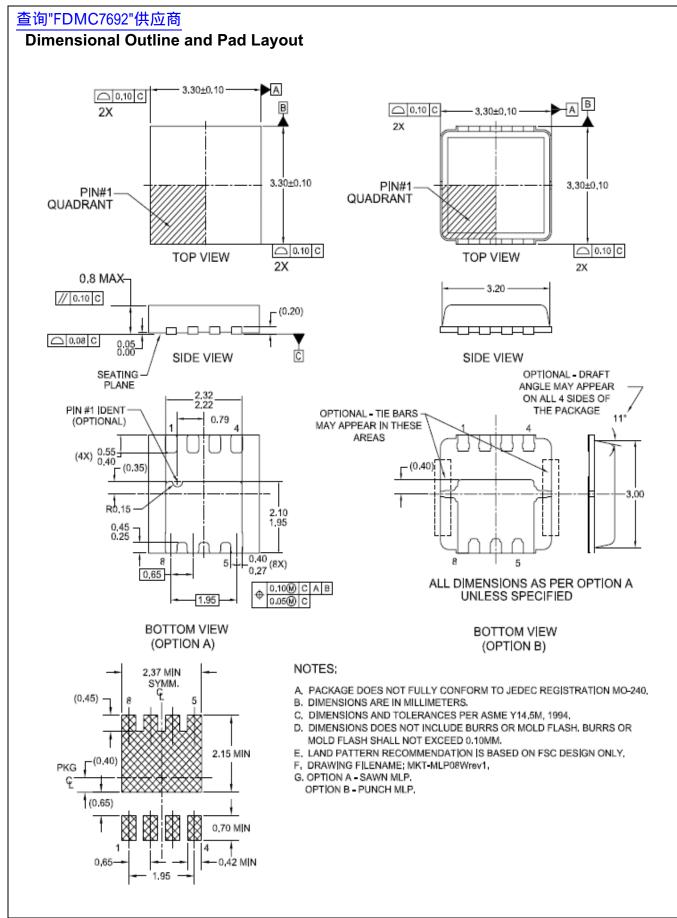
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